**NICHIA CORPORATION** 

**SPECIFICATIONS FOR UV LED** 

# **NCSU275(T)**

- Pb-free Reflow Soldering Application
- Built-in ESD Protection Device
- RoHS Compliant



### **SPECIFICATIONS**

(1) Absolute Maximum Ratings

Item	Symbol	Absolute Maximum Rating	Unit
Forward Current	${ m I}_{\sf F}$	700	mA
Pulse Forward Current	${ m I}_{\sf FP}$	1000	mA
Allowable Reverse Current	$I_{R}$	85	mA
Power Dissipation	$P_{D}$	2.87	W
Operating Temperature	$T_{opr}$	-10~85	°C
Storage Temperature	$T_{stg}$	-40~100	°C
Junction Temperature	Tı	130	°C

<sup>\*</sup> Absolute Maximum Ratings at  $T_S=25$ °C.

(2) Initial Electrical/Optical Characteristics

Item		Symbol	Condition	Тур	Max	Unit
	Forward Voltage	$V_{F}$	I <sub>F</sub> =500mA	3.7	-	V
U405	Radiant Flux	Фе	I <sub>F</sub> =500mA	370	-	mW
	Peak Wavelength	λp	I <sub>F</sub> =500mA	405	-	nm
	Forward Voltage	$V_{F}$	I <sub>F</sub> =500mA	3.6	-	V
U395	Radiant Flux	Фе	I <sub>F</sub> =500mA	360	-	mW
	Peak Wavelength	λp	I <sub>F</sub> =500mA	395	-	nm
	Forward Voltage	$V_{F}$	I <sub>F</sub> =500mA	3.6	-	V
U385	Radiant Flux	Фе	I <sub>F</sub> =500mA	350	-	mW
	Peak Wavelength	λp	I <sub>F</sub> =500mA	385	-	nm
Spectrum	Half Width	Δλ	I <sub>F</sub> =500mA	9.0	-	nm
Thermal Resistance		R <sub>ejs</sub>	-	9.3	10.5	°C/W

<sup>\*</sup> Characteristics at  $T_S$ =25°C.

<sup>\*</sup>  $I_{\text{FP}}$  conditions with pulse width  $\leq 10 \text{ms}$  and duty cycle  $\leq 10 \%$ .

<sup>\*</sup> Radiant Flux value as per CIE 127:2007 standard.

<sup>\*</sup>  $R_{\theta \text{JS}}$  is Thermal Resistance from junction to  $T_S$  measuring point.

<sup>\*</sup> It is recommended to operate the LEDs at a current greater than 10% of the sorting current to stabilize the LED characteristics.

### **RANKS**

Item	Rank	Min	Max	Unit	
Forward Voltage	-	3.3	4.1	V	
	P6	510	605		
	P5	430	510		
Radiant Flux	P4	360	430		
	P3	300	360	mW	
	P2	255	300		
	P1	215	255		
	U405	400	410		
Peak Wavelength	U395	390	400	nm	
	U385	380	390		

\* Ranking at  $T_S=25^{\circ}C$ .

\* Forward Voltage Tolerance: ±0.05V \* Radiant Flux Tolerance: ±10%

\* Peak Wavelength Tolerance: ±3nm

\* LEDs from the above ranks will be shipped.

The rank combination ratio per shipment will be decided by Nichia.

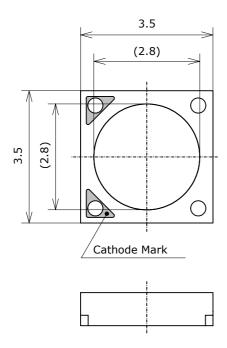
Radiant Flux Ranks by Peak Wavelength

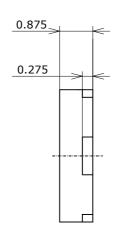
Radialit Hux Raliks by Feak Wavelelly	jui						
Ranking by Peak Wavelength	Ranking by Radiant Flux	P1	P2	P3	P4	P5	P6
U405							
U395							
U385							

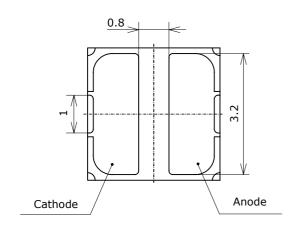
# **OUTLINE DIMENSIONS**

\* 本製品はRoHS指令に適合しております。 This product complies with RoHS Directive. NCSU275 管理番号 No. STS-DA7-3363

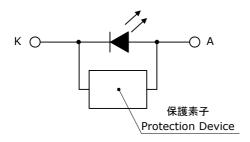
(単位 Unit: mm, 公差 Tolerance: ±0.2)





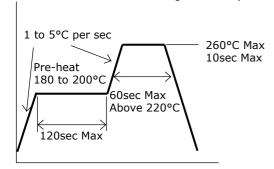


項目 Item	内容 Description	
パッケージ材質 Package Materials	セラミックス Ceramics	
封止樹脂材質 Encapsulating Resin Materials	シリコーン樹脂 Silicone Resin	
電極材質 Electrodes Materials	金メッキ Au-plated	
質量 Weight	0.037g(TYP)	

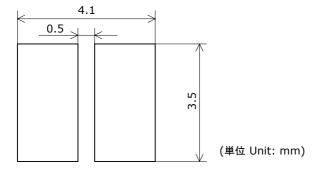


### **SOLDERING**

• Recommended Reflow Soldering Condition(Lead-free Solder)



• Recommended Soldering Pad Pattern

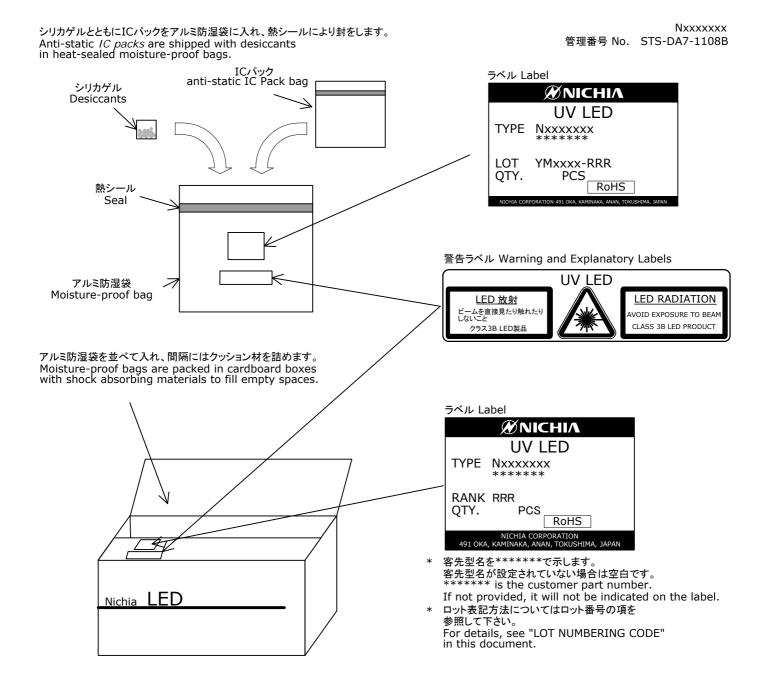


- \* This LED is designed to be reflow soldered on to a PCB. If dip soldered or hand soldered, Nichia cannot guarantee its reliability.
- \* Reflow soldering must not be performed more than twice.
- \* Avoid rapid cooling. Ramp down the temperature gradually from the peak temperature.
- \* Nitrogen reflow soldering is recommended. Air flow soldering conditions can cause optical degradation, caused by heat and/or atmosphere.
- \* Since the silicone used in the encapsulating resin is soft, do not press on the encapsulant resin.

  Pressure can cause nicks, chip-outs, encapsulant delamination and deformation, and wire breaks, decreasing reliability.
- \* Repairing should not be done after the LEDs have been soldered.

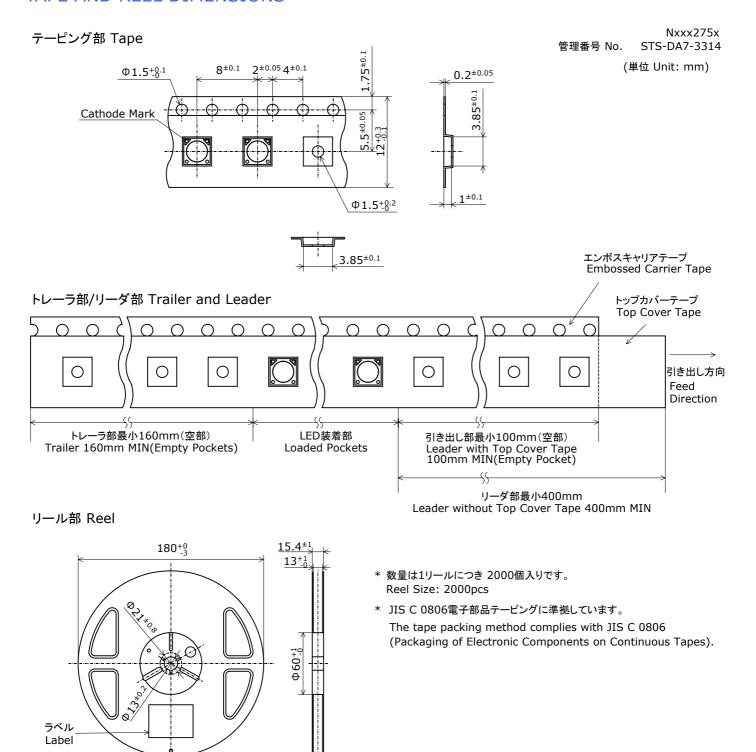
  It should be confirmed beforehand whether the characteristics of the LEDs will or will not be damaged by repairing.
- \* When soldering, do not apply stress to the LED while the LED is hot.

### PACKAGING - BULK

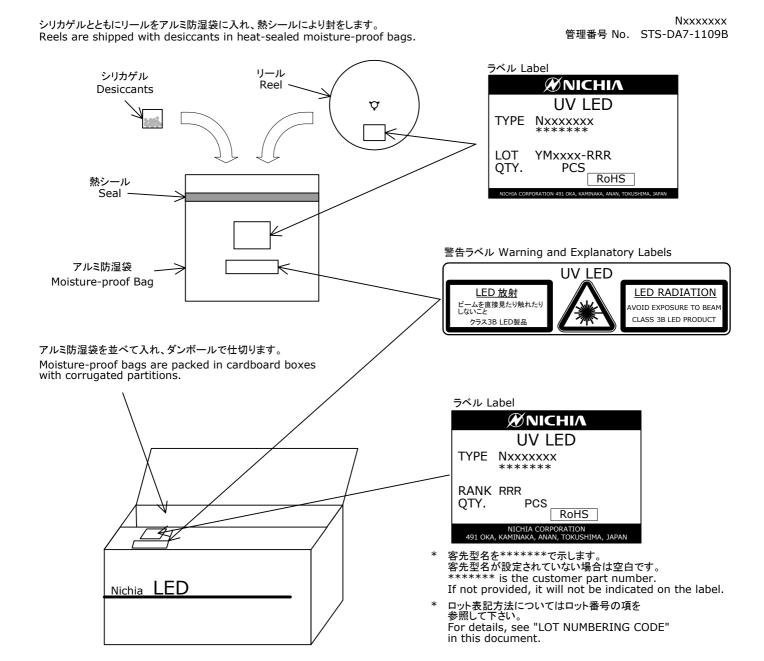


- 本製品はICパックに入れたのち、輸送の衝撃から保護するためダンボールで梱包します。
   Products shipped in anti-static IC packs are packed in a moisture-proof bag.
   They are shipped in cardboard boxes to protect them from external forces during transportation.
- \* 取り扱いに際して、落下させたり、強い衝撃を与えたりしますと、製品を損傷させる原因になりますので注意して下さい。 Do not drop or expose the box to external forces as it may damage the products.
- \* ダンボールには防水加工がされておりませんので、梱包箱が水に濡れないよう注意して下さい。 Do not expose to water. The box is not water-resistant.
- \* 輸送、運搬に際して弊社よりの梱包状態あるいは同等の梱包を行って下さい。
  Using the original package material or equivalent in transit is recommended.

### TAPE AND REEL DIMENSIONS



### PACKAGING - TAPE & REEL



- \* 本製品はテーピングしたのち、輸送の衝撃から保護するためダンボールで梱包します。
  Products shipped on tape and reel are packed in a moisture-proof bag.
  They are shipped in cardboard boxes to protect them from external forces during transportation.
- \* 取り扱いに際して、落下させたり、強い衝撃を与えたりしますと、製品を損傷させる原因になりますので注意して下さい。 Do not drop or expose the box to external forces as it may damage the products.
- \* ダンボールには防水加工がされておりませんので、梱包箱が水に濡れないよう注意して下さい。 Do not expose to water. The box is not water-resistant.
- \* 輸送、運搬に際して弊社よりの梱包状態あるいは同等の梱包を行って下さい。
  Using the original package material or equivalent in transit is recommended.

# LOT NUMBERING CODE

Lot Number is presented by using the following alphanumeric code.

YMxxxx - RRR

Y - Year

Year	Y
2009	9
2010	А
2011	В
2012	С
2013	D
2014	E

M - Month

Month	М	Month	М
1	1	7	7
2	2	8	8
3	3	9	9
4	4	10	А
5	5	11	В
6	6	12	С

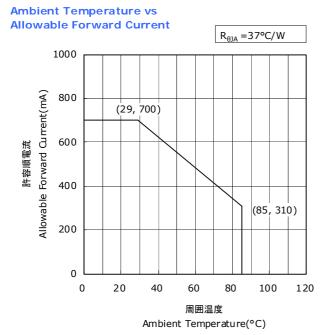
xxxx-Nichia's Product Number

RRR-Ranking by Wavelength, Ranking by Radiant Flux

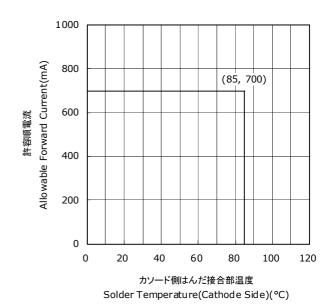
# **DERATING CHARACTERISTICS**

NCSU275 管理番号 No. STS-DA7-3364

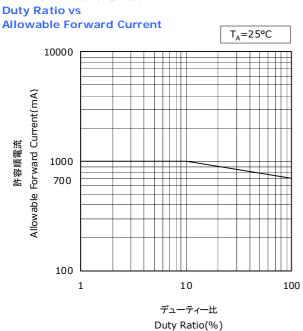
#### 周囲温度-許容順電流特性



#### カソード側はんだ接合部温度-許容順電流特性 Solder Temperature(Cathode Side) vs Allowable Forward Current



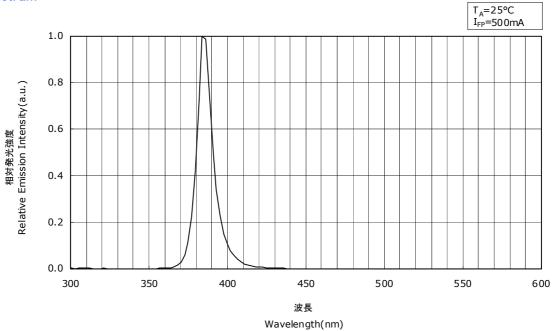
### デューティー比ー許容順電流特性

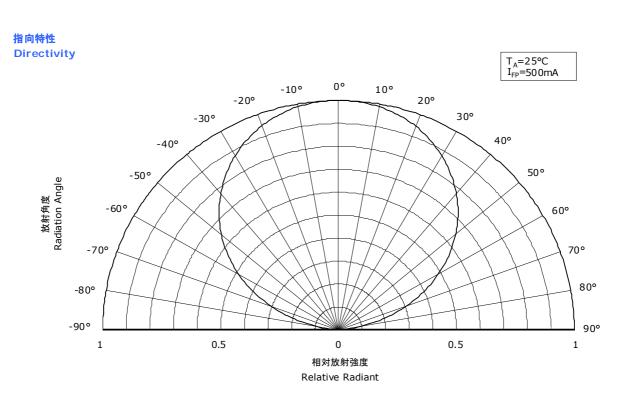


# OPTICAL CHARACTERISTICS

\* 本特性は参考です。 All characteristics shown are for reference only and are not guaranteed. NCSU275 管理番号 No. STS-DA7-3365





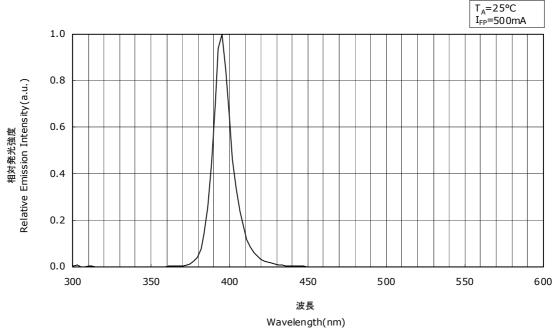


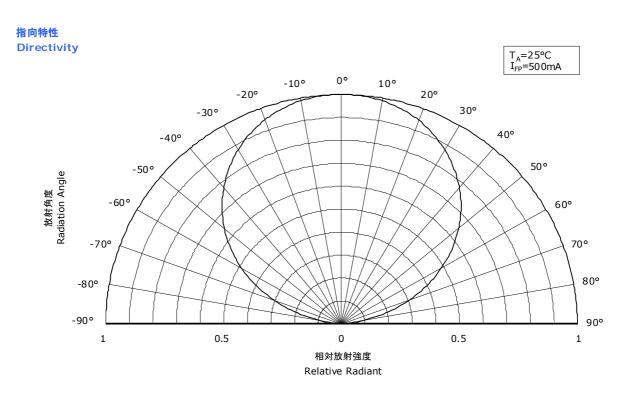
\* 本特性はピーク波長ランクU385に対応しています。
The graphs above show the characteristics for U385 LEDs of this product.

# OPTICAL CHARACTERISTICS

\* 本特性は参考です。 All characteristics shown are for reference only and are not guaranteed. NCSU275 管理番号 No. STS-DA7-3457







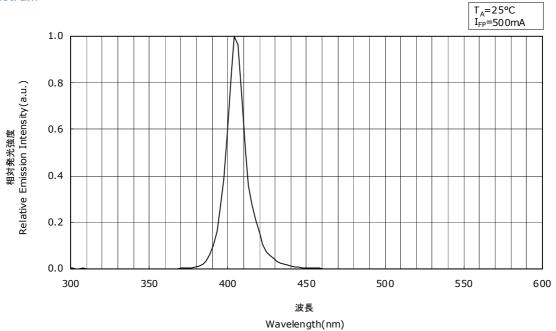
\* 本特性はピーク波長ランクU395に対応しています。
The graphs above show the characteristics for U395 LEDs of this product.

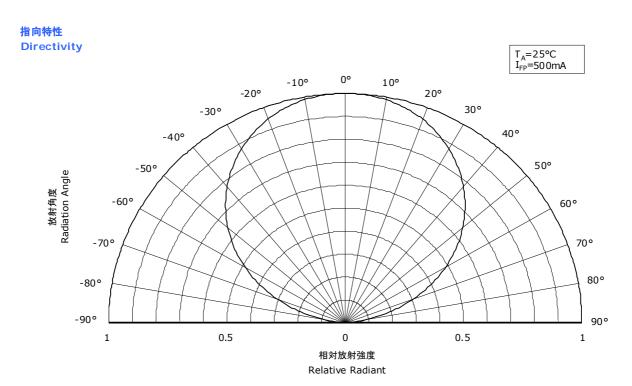
# OPTICAL CHARACTERISTICS

\* 本特性は参考です。 All characteristics shown are for reference only and are not guaranteed.

NCSU275 管理番号 No. STS-DA7-3458





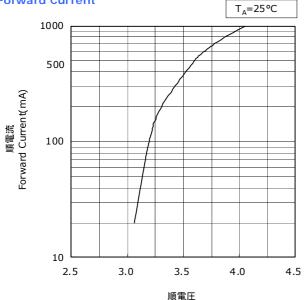


\* 本特性はピーク波長ランクU405に対応しています。
The graphs above show the characteristics for U405 LEDs of this product.

\* 本特性は参考です。 NCSU275 All characteristics shown are for reference only and are not guaranteed. 管理番号 No. STS-DA7-3366



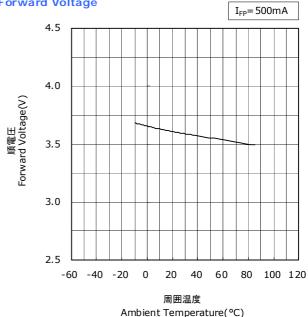
Forward Voltage vs Forward Current



Forward Voltage(V)

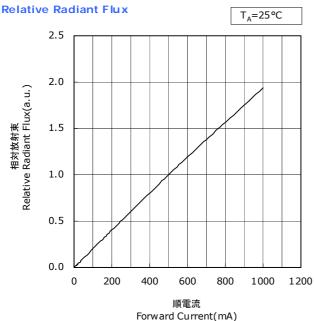
#### 周囲温度-順電圧特性

Ambient Temperature vs Forward Voltage



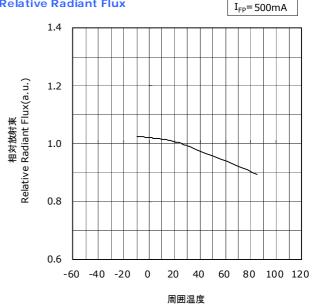
### 順電流-相対放射束特性

Forward Current vs



#### 周囲温度-相対放射束特性

Ambient Temperature vs Relative Radiant Flux



Ambient Temperature(°C)

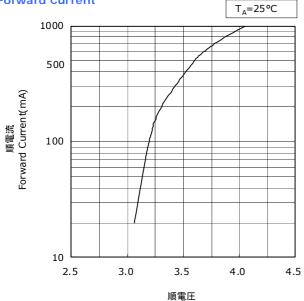
\* 本特性はピーク波長ランクU385に対応しています。

The graphs above show the characteristics for U385 LEDs of this product.

\* 本特性は参考です。 NCSU275 All characteristics shown are for reference only and are not guaranteed. 管理番号 No. STS-DA7-3461



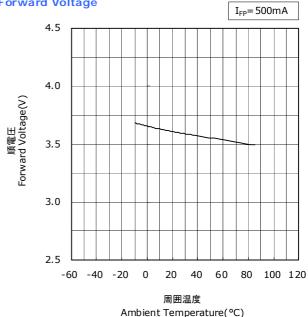
Forward Voltage vs Forward Current



Forward Voltage(V)

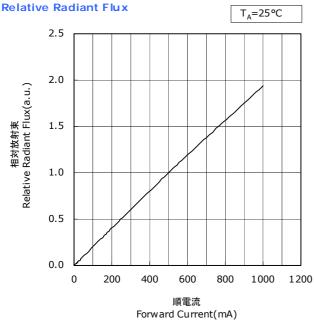
#### 周囲温度-順電圧特性

Ambient Temperature vs Forward Voltage



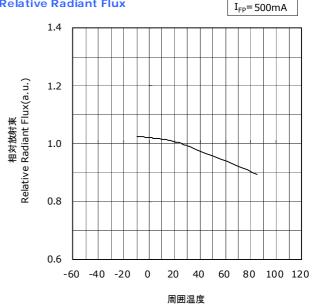
#### 順電流-相対放射束特性

Forward Current vs



#### 周囲温度-相対放射束特性

Ambient Temperature vs Relative Radiant Flux



Ambient Temperature(°C)

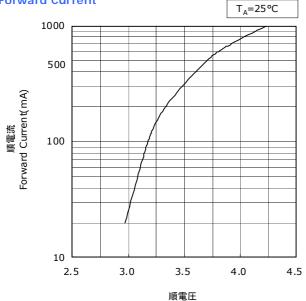
\* 本特性はピーク波長ランクU395に対応しています。

The graphs above show the characteristics for U395 LEDs of this product.

\* 本特性は参考です。 NCSU275 All characteristics shown are for reference only and are not guaranteed. 管理番号 No. STS-DA7-3462



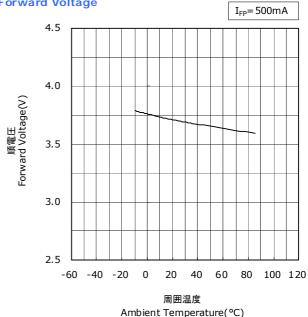
Forward Voltage vs Forward Current



Forward Voltage(V)

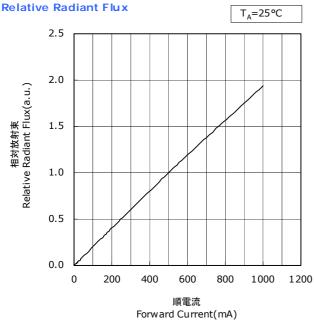
#### 周囲温度-順電圧特性

Ambient Temperature vs Forward Voltage



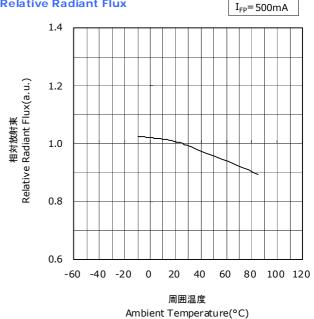
#### 順電流-相対放射束特性

Forward Current vs



#### 周囲温度-相対放射束特性

Ambient Temperature vs Relative Radiant Flux



\* 本特性はピーク波長ランクU405に対応しています。

The graphs above show the characteristics for U405 LEDs of this product.

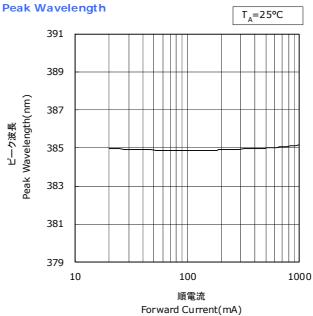
NCSU275

STS-DA7-3367

# FORWARD CURRENT CHARACTERISTICS / TEMPERATURE CHARACTERISTICS

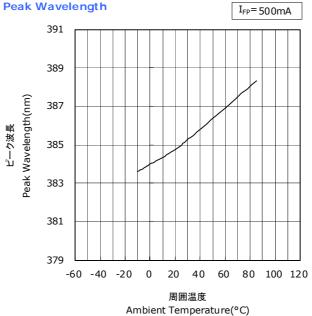
\* 本特性は参考です。
All characteristics shown are for reference only and are not guaranteed. 管理番号 No.

順電流-ピーク波長特性 Forward Current vs Peak Wayelength



#### 周囲温度-ピーク波長特性

Ambient Temperature vs Peak Wavelength

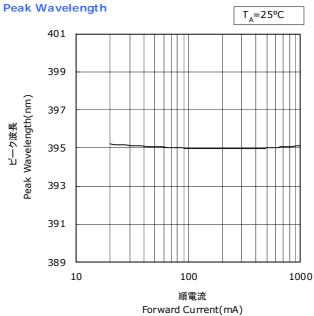


\* 本特性はピーク波長ランクU385に対応しています。

The graphs above show the characteristics for U385 LEDs of this product.

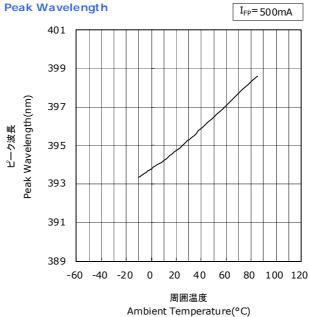
\* 本特性は参考です。 NCSU275 All characteristics shown are for reference only and are not guaranteed. 管理番号 No. STS-DA7-3459

順電流-ピーク波長特性 Forward Current vs Peak Wavelength



#### 周囲温度-ピーク波長特性

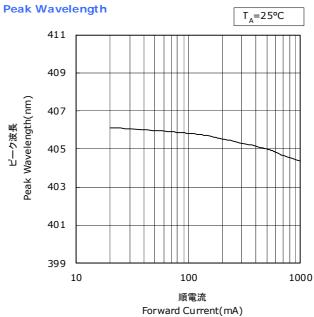
Ambient Temperature vs Peak Wavelength



\* 本特性はピーク波長ランクU395に対応しています。
The graphs above show the characteristics for U395 LEDs of this product.

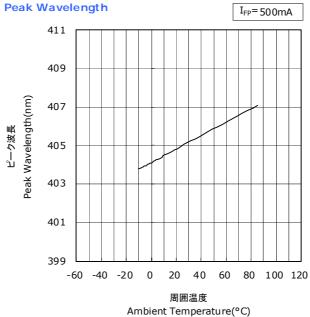
NCSU275 \* 本特性は参考です。 管理番号 No. STS-DA7-3460 All characteristics shown are for reference only and are not guaranteed.

順電流-ピーク波長特性 **Forward Current vs** 



#### 周囲温度-ピーク波長特性

**Ambient Temperature vs** Peak Wavelength



\* 本特性はピーク波長ランクU405に対応しています。 The graphs above show the characteristics for U405 LEDs of this product.

# **RELIABILITY**

# (1) Tests and Results

Test	Reference Standard	Test Conditions	Test Duration	Failure Criteria #	Units Failed/Tested
Resistance to Soldering Heat (Reflow Soldering)		T <sub>sld</sub> =260°C, 10sec, 2reflows		#1	0/10
Temperature Cycle	JEITA ED-4701 100 105	-40°C(30min)~25°C(5min)~ 100°C(30min)~25°C(5min)	100cycles	#1	0/10
High Temperature Storage	JEITA ED-4701 200 201	T <sub>A</sub> =100°C	1000hours	#1	0/10
Low Temperature Storage	JEITA ED-4701 200 202	T <sub>A</sub> =-40°C	1000hours	#1	0/10
Room Temperature Operating Life Condition 1		T <sub>A</sub> =25°C, I <sub>F</sub> =500mA	1000hours	#1	0/10
Room Temperature Operating Life Condition 2		T <sub>A</sub> =25°C, I <sub>F</sub> =700mA	500hours	#1	0/10
High Temperature Operating Life		T <sub>A</sub> =85°C, I <sub>F</sub> =300mA	500hours	#1	0/10
Temperature Humidity Operating Life		60°C, RH=90%, I <sub>F</sub> =300mA	500hours	#1	0/10
Low Temperature Operating Life		T <sub>A</sub> =-10°C, I <sub>F</sub> =500mA	1000hours	#1	0/10
Vibration	JEITA ED-4701 400 403	200m/s², 100~2000~100Hz, 4cycles, 4min, each X, Y, Z	48minutes	#1	0/10
Electrostatic Discharges	JEITA ED-4701 300 304	HBM, 2kV, $1.5k\Omega$ , $100pF$ , $3pulses$ , alternately positive or negative		#1	0/10

### NOTES:

- 1) R<sub>θJA</sub>≈37°C/W
- 2) Measurements are performed after allowing the LEDs to return to room temperature.

### (2) Failure Criteria

Criteria #	Items	Conditions	Failure Criteria
	Forward Voltage(V <sub>F</sub> )	I <sub>F</sub> =500mA	>Initial value×1.1
#1	Radiant Flux( $\Phi_{F}$ )	I <sub>F</sub> =500mA	<initial td="" value×0.7<=""></initial>

#### **CAUTIONS**

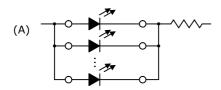
(1) Storage

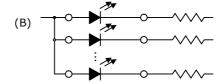
	Conditions	Temperature	Humidity	Time
	Before Opening Aluminum Bag	≤30°C	≤90%RH	Within 1 Year from Delivery Date
Storage	After Opening Aluminum Bag	≤30°C	≤70%RH	≤168hours
Baking		65±5°C	-	≥24hours

- Product complies with JEDEC MSL 3 or equivalent. See IPC/JEDEC STD-020 for moisture-sensitivity details.
- Absorbed moisture in LED packages can vaporize and expand during soldering, which can cause interface delamination
  and result in optical performance degradation. Products are packed in moisture-proof aluminum bags
  to minimize moisture absorption during transportation and storage.
  - Included silica gel desiccants change from blue to red if moisture had penetrated bags.
- After opening the moisture-proof aluminum bag, the products should go through the soldering process within the range of the conditions stated above. Unused remaining LEDs should be stored with silica gel desiccants in a hermetically sealed container, preferably the original moisture-proof bags for storage.
- After the "Period After Opening" storage time has been exceeded or silica gel desiccants are no longer blue, the products should be baked. Baking should only be done once.
- Although the leads or electrode pads (anode and cathode) of the product are plated with gold,
  prolonged exposure to a corrosive environment might cause the gold plated the leads or electrode pads to tarnish,
  and thus leading to difficulties in soldering. If unused LEDs remain, they must be stored in a hermetically sealed container.
   Nichia recommends using the original moisture-proof bag for storage.
- Do not use sulfur-containing materials in commercial products. Some materials, such as seals and adhesives, may contain sulfur. The contaminated plating of LEDs might cause an open circuit. Silicone rubber is recommended as a material for seals. Bear in mind, the use of silicones may lead to silicone contamination of electrical contacts inside the products, caused by low molecular weight volatile siloxane.
- To prevent water condensation, please avoid large temperature and humidity fluctuations for the storage conditions.

#### (2) Directions for Use

When designing a circuit, the current through each LED must not exceed the Absolute Maximum Rating.
 Operating at a constant current per LED is recommended. In case of operating at a constant voltage, Circuit B is recommended.
 If the LEDs are operated with constant voltage using Circuit A, the current through the LEDs may vary due to the variation in Forward Voltage characteristics of the LEDs.





- LEDs should be operated in forward bias. Driving circuits must not subject LEDs to either forward or reverse voltage while off.

  Continuous reverse voltage can cause migration and LED damage.
- It is recommended to operate the LEDs at a current greater than 10% of the sorting current to stabilize the LED characteristics.
- For outdoor use, necessary measures should be taken to prevent water, moisture and salt air damage.
- This LED also emits visible light. Please take notice of visible light spectrum, in case you use this LED as light source of sensors etc.

### (3) Handling Precautions

- Do not handle LEDs with bare hands, it may contaminate the LED surface and affect optical characteristics.
  - In the worst case, catastrophic failure from excess pressure through wire-bond breaks and package damage may result.
- This product uses encapsulating resin that is very soft. Direct contact with the surface of the resin may cause damage to the resin; the application of force on the resin may cause the wire to break and/or cause the LED not to illuminate.
  - When handling the LEDs with tweezers, make sure to avoid direct contact with the resin and that excessive force is not applied to the LEDs.
- Dropping the product may cause damage.
- Do not stack assembled PCBs together. Failure to comply can cause the resin portion of the product to be cut, chipped, delaminated and/or deformed. It may cause wire to break, leading to catastrophic failures.

#### (4) Design Consideration

- PCB warpage after mounting the products onto a PCB can cause the package to break.
  - The LED should be placed in a way to minimize the stress on the LEDs due to PCB bow and twist.
- The position and orientation of the LEDs affect how much mechanical stress is exerted on the LEDs placed near the score lines.

  The LED should be placed in a way to minimize the stress on the LEDs due to board flexing.
- Board separation must be performed using special jigs, not using hands.
- If an aluminum PCB is used, customer is advised to verity the PCB with the products before use.
  - Thermal stress during use can cause the solder joints to crack.
- Part of the surface of the encapsulating resin may appear frosted or cloudy during use.
  - This is the area where the material properties have changed due to the ultra-violet light.
  - The appearance of the cloudy spots will not cause an adverse effect on the electrical/optical characteristics.
  - However, ensure that there are no issues for the chosen application prior to use.
- When substances commonly found in ink adhere to the resin of this product, it may reduce the radiant flux and may change the material properties. Materials, such as dustproof glass, should be used to protect the LEDs.

### (5) Electrostatic Discharge (ESD)

• The products are sensitive to static electricity or surge voltage. ESD can damage a die and its reliability.

When handling the products, the following measures against electrostatic discharge are strongly recommended:

Eliminating the charge

Grounded wrist strap, ESD footwear, clothes, and floors

Grounded workstation equipment and tools

ESD table/shelf mat made of conductive materials

- Proper grounding is required for all devices, equipment, and machinery used in product assembly.
  - Surge protection should be considered when designing of commercial products.
- If tools or equipment contain insulating materials such as glass or plastic,

the following measures against electrostatic discharge are strongly recommended:

Dissipating static charge with conductive materials

Preventing charge generation with moisture

Neutralizing the charge with ionizers

- The customer is advised to check if the LEDs are damaged by ESD
  - when performing the characteristics inspection of the LEDs in the application.
- Damage can be detected with a forward voltage measurement at low current ( $\leq 1$ mA).
- ESD damaged LEDs may have current flow at a low voltage.

Failure Criteria:  $V_F$ <2.0V at  $I_F$ =0.5mA

#### (6) Thermal Management

- Proper thermal management is an important when designing products with LEDs. LED die temperature is affected by PCB thermal resistance and LED spacing on the board. Please design products in a way that the LED die temperature does not exceed the maximum Junction Temperature (T<sub>J</sub>).
- Drive current should be determined for the surrounding ambient temperature (TA) to dissipate the heat from the product.
- The following equations can be used to calculate the junction temperature of the products.
  - 1)  $T_J = T_A + R_{\theta JA} \cdot W$  2)  $T_J = T_S + R_{\theta JS} \cdot W$

\*T<sub>J</sub>=LED junction temperature: °C

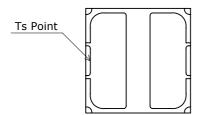
T<sub>A</sub>=Ambient temperature: °C

T<sub>S</sub>=Soldering temperature (cathode side): °C

 $R_{\theta JA}$ =Thermal resistance from junction to ambient: °C/W

 $R_{\theta JS}$ =Thermal resistance from junction to  $T_S$  measuring point: °C/W

 $W=Input power(I_F \times V_F)$ : W



#### (7) Cleaning

- If required, isopropyl alcohol (IPA) should be used. Other solvents may cause premature failure to the LEDs due to the damage to the resin portion. The effects of such solvents should be verified prior to use.

  In addition, the use of CFCs such as Freon is heavily regulated.
- Ultrasonic cleaning is not recommended since it may have adverse effects on the LEDs
  depending on the ultrasonic power and how LED is assembled.
   If ultrasonic cleaning must be used, the customer is advised to make sure the LEDs will not be damaged prior to cleaning.

#### (8) Eye Safety

• In 2006, the International Electrical Commission (IEC) published IEC 62471:2006 Photobiological safety of lamps and lamp systems, which added LEDs in its scope.

On the other hand, the IEC 60825-1:2007 laser safety standard removed LEDs from its scope.

However, please be advised that some countries and regions have adopted standards

based on the IEC laser safety standard IEC 60825-1:20112001, which still includes LEDs in its scope.

Most of Nichia's LEDs can be classified as belonging into either the Exempt Group or Risk Group 1.

High-power LEDs, that emit light containing blue wavelengths, may be classified as Risk Group 2.

Please proceed with caution when viewing directly any LEDs driven at high current, or viewing LEDs with optical instruments which may greatly increase the damages to your eyes.

- Viewing a flashing light may cause eye discomfort. When incorporating the LED into your product, please be careful to avoid adverse effects on the human body caused by light stimulation.
- The products are UV light LEDs, and radiate intense UV light during operation. Since UV light can be harmful to eyes, do NOT look directly into the UV light, even through an optical instrument. In case of the light reflection, UV protective glasses are required to use in order to avoid damage by the light.

#### (9) Others

- The LEDs described in this brochure are intended to be used for ordinary electronic equipment (such as office equipment, communications equipment, measurement instruments and household appliances).
   Consult Nichia's sales staff in advance for information on the applications in which exceptional quality and reliability are required, particularly when the failure or malfunction of the LEDs may directly jeopardize life or health (such as for airplanes, aerospace, submersible repeaters, nuclear reactor control system, automobiles, traffic control equipment, life support systems and safety devices).
- The customer shall not reverse engineer by disassembling or analysis of the LEDs without having prior written consent from Nichia. When defective LEDs are found, the customer shall inform Nichia directly before disassembling or analysis.
- Both the customers and Nichia will agree on official specifications of supplied products before a customer's volume production.
- Specifications and appearance subject to change for improvement without notice.